


PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCN No.	EMBEDDED PROCESSING/26/15268	
1.3 Title of PCN	ASE Kaohsiung (Taiwan) additional source for STM32H56x and STM32H57x listed products in VQFPN 8X8 package	
1.4 Product Category	STM32H56x and STM32H57x	
1.5 Issue date	2026-04-09	

2. PCN Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Patrick AIDOUNE
2.1.2 Marketing Manager	Marie TOURNUT
2.1.3 Quality Manager	Pascal NARCHE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617)	ASE Kaohsiung (Taiwan)

4. Description of change

	Old	New
4.1 Description	Current assembly sites: - JSCC (China) in Copper Palladium wire	Current assembly site : - JSCC (China) in Copper Palladium wire Additional assembly site for extended capacity: - ASE KaoHsiung (Taiwan) in copper palladium wire
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	no impact on Form, Fit, Function	

5. Reason / motivation for change

5.1 Motivation	Due to the success on the market of STM32 devices, ST General Purpose and Automotive Microcontrollers division decided to qualify an additional back-end site to maintain state of the art service level to our customers thanks to extra capacity.
5.2 Customer Benefit	SERVICE IMPROVEMENT

6. Marking of parts / traceability of change

6.1 Description	traceability ensured by ST Internal tools
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7. Timing / schedule

7.1 Date of qualification results	2025-10-24
7.2 Intended start of delivery	2025-10-24
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	15268 MDG-GPM-RER2323 ASE UQFN 32L_48L_ VQFN 68LCuPd wires STM32-plan.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2026-04-09

9. Attachments (additional documentations)

15268 Public product.pdf
15268 MDG-GPM-RER2323 ASE UQFN 32L_48L_ VQFN 68LCuPd wires STM32-plan.pdf
15268 _Additional information.pdf

10. Affected parts

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STM32H562RGV6	
	STM32H562RIV6	
	STM32H563RGV6	
	STM32H563RIV6	
	STM32H573RIV6	

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